PTO/SB/05 (06-03)

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UTILITY PATENT APPLICATION **TRANSMITTAL**

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Attorney Docket No.	040008-0307318	
First Inventor	JAE WON HAN	
Title	See attached addendum	
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APPLICATION ELEMENTS See MPEP chapter 600 concerning utility patent application contents.	ADDRESS TO: Commissi	Patent Application oner for Patents 1450 a VA 22313-1450	
1. Fee Transmittal Form (e.g., PTO/SB/17) (Submit an original and a duplicate for fee processing) Applicant claims small entity status. See 37 CFR 1.27. 3. X Specification [Total Pages 10] (preferred arrangement set forth below) - Descriptive title of the invention - Cross Reference to Related Applications - Statement Regarding Fed sponsored R & D - Reference to sequence listing, a table, or a computer program listing appendix - Background of the Invention - Brief Description of the Drawings (if filed) - Detailed Description	ii. Paper	ndix) Sequence Submission orm (CRF) nce Listing on: D-R (2 copies); or identity of above copies	
- Claim(s) - Abstract of the Disclosure	ACCOMPANYING AP	PLICATION PARTS	
4. X Drawing(s) (35 U.S.C. 113) [Total Sheets 3] 5. Oath or Declaration [Total Sheets] a. Newly executed (original or copy) b. Copy from a prior application (37 CFR 1.63(d)) (for continuationIdivisional with Box 18 completed) i. DELETION OF INVENTOR(S) Signed statement attached deleting inventor(s) name in the prior application, see 37 CFR 1.63(d)(2) and 1.33(b). 6. X Application Data Sheet. See 37 CFR 1.76 18. If a CONTINUING APPLICATION, check appropriate box, and suppropriate specification following the title, or in an Application Data Sheet under 37 Continuation Divisional Continuation: Prior application information: Examiner For CONTINUATION OF DIVISIONAL APPS only; The entire disclosure of the 5b, is considered a part of the disclosure of the accompanying continuation	or its equivalent. Other: If the requisite information below and CFR 1.76: Ition-in-part (CIP) of prior application Art Unit: In prior application, from which an oath of or divisional application and is hereby in the content of	Attorney Jument (if applicable) Jument (if applicable) Jument (if applicable) Gopies of IDS Citations (MPEP 503) Emized) Document(s) Jument 35 U.S.C. 122 Just attach form PTO/SB/35 In the first sentence of the In No.: In declaration is supplied under Box incorporated by reference.	
The incorporation can only be relied upon when a portion has been inadvertently omitted from the submitted application parts. 19. CORRESPONDENCE ADDRESS			
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This collection of information is required by 37 OFR 1.53(b). The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 12 minutes to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Mail Stop Patent Application, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Addendum

Invention Title

METHOD OF FABRICATING METAL INTERCONNECTION OF SEMICONDUCTOR DEVICE